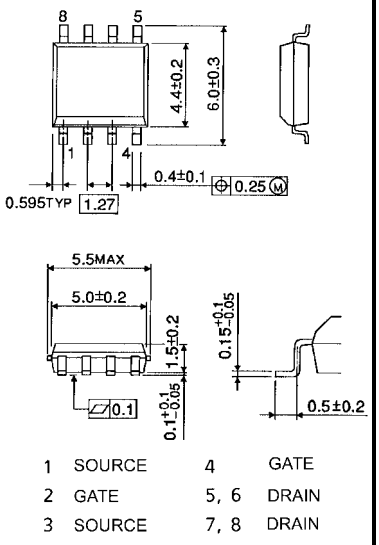
TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U−MOS III)

TPC8211

Lithium Ion Battery Applications
Portable Equipment Applications
Notebook PC Applications

- Low drain−source ON resistance: $R_{DS\ (ON)}$ = 25 mΩ (typ.)
- High forward transfer admittance: $|Y_{fs}|$ = 7.0 S (typ.)
- Low leakage current: I_{DSS} = 10 μA (max) (V_{DS} = 30 V)
- Enhancement−mode: V_{th} = 1.3 to 2.5 V (V_{DS} = 10 V, I_D = 1 mA)

Unit: mm



JEDEC	—
JEITA	—
TOSHIBA	2-6J1E

Weight: 0.08 g (typ.)

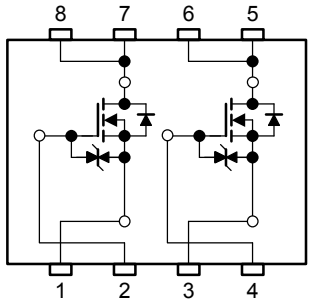
Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	30	V
Drain-gate voltage (R_{GS} = 20 kΩ)		V_{DGR}	30	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	D C (Note 1)	I_D	5.5	A
	Pulse (Note 1)	I_{DP}	22	
Drain power dissipation (t = 10 s) (Note 2a)	Single-device operation (Note 3a)	$P_{D\ (1)}$	1.5	W
	Single-device value at dual operation (Note 3b)	$P_{D(2)}$	1.1	
Drain power dissipation (t = 10 s) (Note 2b)	Single-device operation (Note 3a)	$P_{D\ (1)}$	0.75	W
	Single-device value at dual operation (Note 3b)	$P_{D\ (2)}$	0.45	
Single pulse avalanche energy (Note 4)		E_{AS}	39.3	mJ
Avalanche current		I_{AR}	5.5	A
Repetitive avalanche energy Single-device value at dual operation (Note 2a, 3b, 5)		E_{AR}	0.1	mJ
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	−55 to 150	°C

Note: For (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5), please refer to the next page.

This transistor is an electrostatic sensitive device. Please handle with caution.

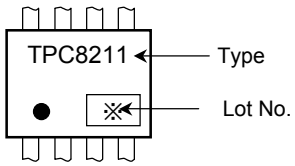
Circuit Configuration



Thermal Characteristics

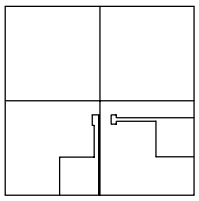
Characteristics		Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	Single-device operation (Note 3a)	$R_{th\ (ch\text{-}a)\ (1)}$	83.3	°C/W
	Single-device value at dual operation (Note 3b)	$R_{th\ (ch\text{-}a)\ (2)}$	114	
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	Single-device operation (Note 3a)	$R_{th\ (ch\text{-}a)\ (1)}$	167	
	Single-device value at dual operation (Note 3b)	$R_{th\ (ch\text{-}a)\ (2)}$	278	

Marking (Note 6)



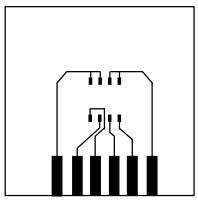
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:



FR-4
25.4 × 25.4 × 0.8
(unit: mm)

(a)



FR-4
25.4 × 25.4 × 0.8
(unit: mm)

(b)

a) Device mounted on a glass-epoxy board (a) b) Device mounted on a glass-epoxy board (b)

Note 3:

a) The power dissipation and thermal resistance values are shown for a single device. (During single-device operation, power is only applied to one device.)

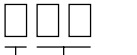
b) The power dissipation and thermal resistance values are shown for a single device. (During dual operation, power is evenly applied to both devices.)

Note 4: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 1.0 mH, R_G = 25 Ω, I_{AR} = 5.5 A

Note 5: Repetitive rating: pulse width limited by maximum channel temperature

Note 6: • on lower left of the marking indicates Pin 1.

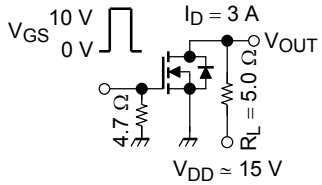
※ Weekly code: (Three digits)



Week of manufacture
(01 for first week of year, continues up to 52 or 53)

Year of manufacture
(One low-order digits of calendar year)

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	—	—	±10	μA
Drain cut−OFF current		I_{DSS}	V_{DS} = 30 V, V_{GS} = 0 V	—	—	10	μA
Drain−source breakdown voltage		$V_{(BR)\ DSS}$	I_D = 10 mA, V_{GS} = 0 V	30	—	—	V
		$V_{(BR)\ DSS}$	I_D = 10 mA, V_{GS} = −20 V	15	—	—	
Gate threshold voltage		V_{th}	V_{DS} = 10 V, I_D = 1 mA	1.3	—	2.5	V
Drain−source ON resistance		$R_{DS\ (ON)}$	V_{GS} = 4.5 V, I_D = 3 A	—	31	44	mΩ
		$R_{DS\ (ON)}$	V_{GS} = 10 V, I_D = 3 A	—	25	36	
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = 10 V, I_D = 3 A	3.5	7.0	—	S
Input capacitance		C_{iss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	—	1250	—	pF
Reverse transfer capacitance		C_{rss}		—	155	—	
Output capacitance		C_{oss}		—	170	—	
Switching time	Rise time	tr	 Duty ≦ 1%, t_w = 10 μs	—	5	—	ns
	Turn−ON time	t_{on}		—	11	—	
	Fall time	t_f		—	9	—	
	Turn−OFF time	t_{off}		—	63	—	
Total gate charge (Gate−source plus gate−drain)		Q_g	V_{DD} ≈ 24 V, V_{GS} = 10 V, I_D = 5.5 A	—	25	—	nC
Gate−source charge		Q_{gs}		—	20	—	
Gate−drain (“miller”) charge		Q_{gd}		—	5	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	I_{DRP}	—	—	—	22	A
Forward voltage (diode)		V_{DSF}	I_{DR} = 5.5 A, V_{GS} = 0 V	—	—	−1.2	V

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